

PHOTOTRANSISTOR

Part Number: KM-4457P3C

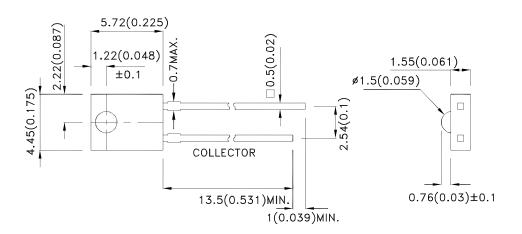
Features

- Mechanically and spectrally matched to infrared emitting LED lamp.
- RoHS compliant.

Description

Made with NPN silicon phototransistor chips.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
- Lead spacing is measured where the leads emerge from the package.
 The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAB0353 APPROVED: WYNEC

REV NO: V.9 CHECKED: Allen Liu

DATE: JAN/24/2013 DRAWN: Y.Liu

PAGE: 1 OF 3 ERP: 1202001801

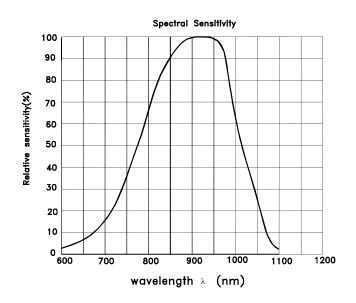
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Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
VBR CEO	Collector-to-Emitter Breakdown Voltage	30			V	Ic=100uA Ee=0mW/c m²
VBR ECO	Emitter-to-Collector Breakdown Voltage	5			V	IE=100uA Ee=0mW/c m²
VCE (SAT)	Collector-to-Emitter Saturation Voltage			0.8	V	Ic=2mA Ee=20mW/c m³
I CEO	Collector Dark Current			100	nA	VcE=10V Ee=0mW/c m³
Tr	Rise Time (10% to 90%)		15		us	VcE = 5V Ic=1mA RL=1000Ω
TF	Fall Time (90% to 10%)		15		us	
I (ON)	On State Collector Current	0.35	0.8		mA	VcE = 5V Ee=1mW/c m ² λ=940nm

Absolute Maximum Ratings at TA=25°C

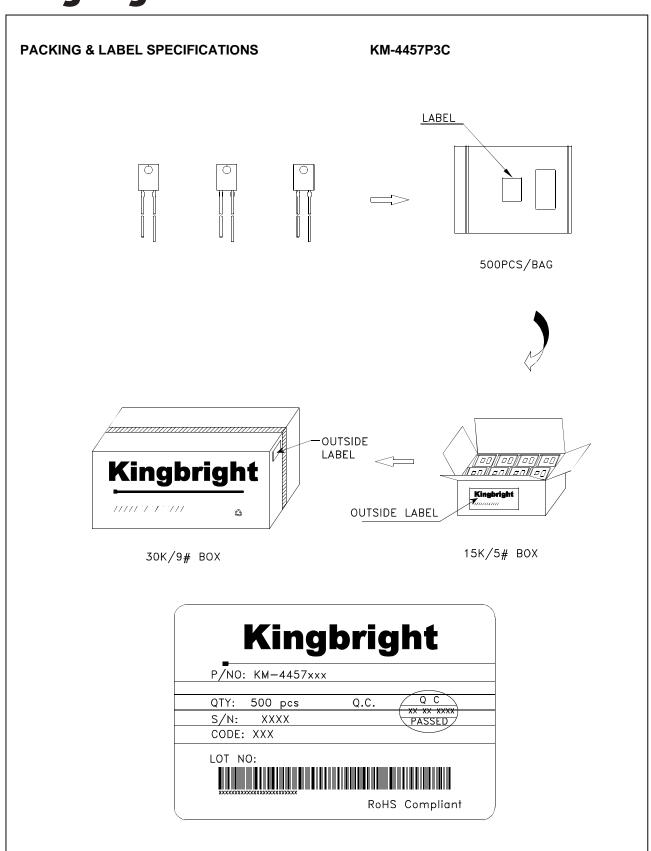
Parameter	Max.Ratings			
Collector-to-Emitter Voltage	30V			
Emitter-to-Collector Voltage	5V			
Power Dissipation at (or below) 25°C Free Air Temperature	100mW			
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			
Lead Soldering Temperature (>5mm for 5sec)	260°C			



 SPEC NO: DSAB0353
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 PAGE: 2 OF 3

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Detailed application notes are listed on our website. http://www.kingbright.com/application notes

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